

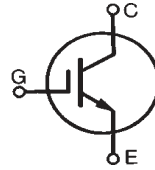
HiPerFAST™ IGBT

Short Circuit SOA Capability

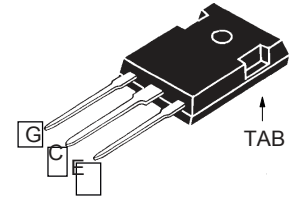
IXSH24N60

IXSH24N60A

| V_{CES} | I_{C90} | $V_{CE(sat)}$ |
|-----------|-----------|---------------|
| 600V | 24A | 2.2V |
| 600V | 24A | 2.7V |



TO-247 (IXSH)



G = Gate C = Collector
E = Emitter TAB = Collector

| Symbol | Test Conditions | Maximum Ratings | |
|----------------------------|---|----------------------|------------------|
| V_{CES} | $T_J = 25^\circ\text{C}$ to 150°C | 600 | V |
| V_{CGR} | $T_J = 25^\circ\text{C}$ to 150°C , $R_{GE} = 1\text{M}\Omega$ | 600 | V |
| V_{GES} | Continuous | ± 20 | V |
| V_{GEM} | Transient | ± 30 | V |
| I_{C25} | $T_C = 25^\circ\text{C}$ | 48 | A |
| I_{C90} | $T_C = 90^\circ\text{C}$ | 24 | A |
| I_{CM} | $T_C = 25^\circ\text{C}$, 1ms | 96 | A |
| SSOA | $V_{GE} = 15\text{V}$, $T_J = 125^\circ\text{C}$, $R_G = 10\Omega$ | $I_{CM} = 48$ | A |
| (RBSOA) | Clamped inductive load | $@0.8 \cdot V_{CES}$ | V |
| t_{SC} (SCSOA) | $V_{GE} = 15\text{V}$, $V_{CE} = 360\text{V}$, $T_J = 125^\circ\text{C}$ $R_G = 82\Omega$, non repetitive | 10 | μs |
| P_C | $T_C = 25^\circ\text{C}$ | 150 | W |
| T_J | | -55 ... +150 | $^\circ\text{C}$ |
| T_{JM} | | 150 | $^\circ\text{C}$ |
| T_{stg} | | -55 ... +150 | $^\circ\text{C}$ |
| M_d | Mounting torque | 1.13 / 10 | Nm/lb.in. |
| T_L | Maximum lead temperature for soldering | 300 | $^\circ\text{C}$ |
| T_{SOLD} | 1.6mm (0.062 in.) from case for 10s | 260 | $^\circ\text{C}$ |
| Weight | | 6 | g |

Features

- International standard package JEDEC TO-247AD
- High frequency IGBT with guaranteed Short Circuit SOA Capability
- 2nd generation HDMOS™ process
- Low $V_{CE(SAT)}$
- for low on-state conduction losses
- MOS Gate turn-on
- drive simplicity

Applications

- AC motor speed control
- DC servo and robot drives
- DC choppers
- Uninterruptible power supplies (UPS)
- Switch-mode and resonant-mode power supplies
- Welding

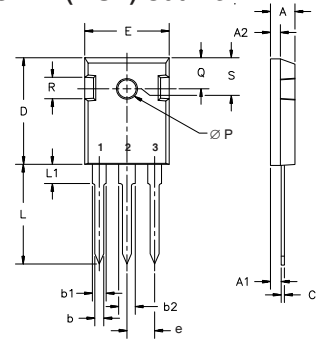
Advantages

- Easy to mount with 1 screw (isolated mounting screw hole)
- Switching speed for high frequency applications
- High power density

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$, unless otherwise specified) | Characteristic Values | | |
|---------------|---|-----------------------|------|---------------------------|
| | | Min. | Typ. | Max. |
| BV_{CES} | $I_C = 250\mu\text{A}$, $V_{CE} = V_{GE}$ | 600 | | V |
| $V_{GE(th)}$ | $I_C = 1.5\text{mA}$, $V_{CE} = V_{GE}$ | 4.0 | | 7.0 V |
| I_{CES} | $V_{CE} = 0.8 \cdot V_{CES}$ $V_{GE} = 0\text{V}$ $T_J = 125^\circ\text{C}$ | | | 200 μA 1 mA |
| I_{GES} | $V_{CE} = 0\text{V}$, $V_{GE} = \pm 20\text{V}$ | | | ± 100 nA |
| $V_{CE(sat)}$ | $I_C = 24\text{A}$, $V_{GE} = 15\text{V}$, Note 1 | IXSH24N60 | | 2.2 V |
| | | IXSH24N60A | | 2.7 V |

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$, unless otherwise specified) | Characteristic Values | | | |
|--------------|--|-----------------------|------|------|--------------------|
| | | Min. | Typ. | Max. | |
| g_{fs} | $I_C = 24\text{A}$, $V_{CE} = 10\text{V}$, Note 1 | 9 | 23 | S | |
| $I_{C(ON)}$ | $V_{GE} = 15\text{V}$, $V_{CE} = 10\text{V}$ | | 65 | A | |
| C_{ies} | $V_{CE} = 25\text{V}$, $V_{GE} = 0\text{V}$, $f = 1\text{MHz}$ | | 1800 | pF | |
| C_{oes} | | | 160 | pF | |
| C_{res} | | | 45 | pF | |
| Q_g | $I_C = 24\text{A}$, $V_{GE} = 15\text{V}$, $V_{CE} = 0.5 \cdot V_{CES}$ | | 75 | 90 | nC |
| Q_{ge} | | | 20 | 30 | nC |
| Q_{gc} | | | 35 | 50 | nC |
| $t_{d(on)}$ | Inductive load, $T_J = 25^\circ\text{C}$ $I_C = 24\text{A}$, $V_{GE} = 15\text{V}$ $V_{CE} = 480\text{V}$, $R_G = 10\Omega$ | | 100 | | ns |
| t_{ri} | | | 200 | | ns |
| $t_{d(off)}$ | | | 450 | | ns |
| t_{fi} | | IXSH24N60 | 500 | | ns |
| E_{off} | | IXSH24N60A | 275 | | ns |
| | IXSH24N60A | 2.0 | | mJ | |
| $t_{d(on)}$ | Inductive load, $T_J = 125^\circ\text{C}$ $I_C = 24\text{A}$, $V_{GE} = 15\text{V}$ $V_{CE} = 480\text{V}$, $R_G = 10\Omega$ | | 100 | | ns |
| t_{ri} | | | 200 | | ns |
| E_{on} | | | 1.2 | | mJ |
| $t_{d(off)}$ | | IXSH24N60 | 475 | | ns |
| | | IXSH24N60A | 600 | | ns |
| t_{fi} | | IXSH24N60 | 450 | | ns |
| E_{off} | IXSH24N60 | 4.0 | | mJ | |
| | IXSH24N60A | 3.0 | | mJ | |
| R_{thJC} | | | | 0.83 | $^\circ\text{C/W}$ |
| R_{thCK} | | 0.21 | | | $^\circ\text{C/W}$ |

TO-247 (IXSH) Outline



Terminals: 1 - Gate 2 - Drain
3 - Source Tab - Drain

| Dim. | Millimeter | | Inches | |
|----------------|------------|-------|--------|-------|
| | Min. | Max. | Min. | Max. |
| A | 4.7 | 5.3 | .185 | .209 |
| A ₁ | 2.2 | 2.54 | .087 | .102 |
| A ₂ | 2.2 | 2.6 | .059 | .098 |
| b | 1.0 | 1.4 | .040 | .055 |
| b ₁ | 1.65 | 2.13 | .065 | .084 |
| b ₂ | 2.87 | 3.12 | .113 | .123 |
| C | .4 | .8 | .016 | .031 |
| D | 20.80 | 21.46 | .819 | .845 |
| E | 15.75 | 16.26 | .610 | .640 |
| e | 5.20 | 5.72 | 0.205 | 0.225 |
| L | 19.81 | 20.32 | .780 | .800 |
| L1 | | 4.50 | | .177 |
| ØP | 3.55 | 3.65 | .140 | .144 |
| Q | 5.89 | 6.40 | 0.232 | 0.252 |
| R | 4.32 | 5.49 | .170 | .216 |
| S | 6.15 | BSC | 242 | BSC |

Notes: 1. Pulse test, $t \leq 300\mu\text{s}$; duty cycle, $d \leq 2\%$.

ADVANCE TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

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IXYS MOSFETs and IGBTs are covered 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2
by one or more of the following U.S. patents: 4,850,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2
4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537